



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

U.S. Serial No. 10/741,498

Applicants: Lee

Title: Methods to Fabricate

Semiconductor Devices

Filed: December 19, 2003

TC/AU: 2818

Examiner: Calvin Lee

Docket No.:

20067/OPP031055US

) I hereby certify that this paper (and/or fee)
) is being deposited with the United States
) Postal Service as first class mail in an
) envelope addressed to:

) Mail Stop Amendment
) Commissioner for Patents
) P.O. Box 1450
) Alexandria, VA 22313-1450
) on this date:

) Dated: June 6, 2005

) Mark C. Zimmerman
) Registration No. 44,006

**Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450**

RESPONSE TO THE OFFICE ACTION DATED FEBRUARY 4, 2005

Dear Sir:

Please enter the following amendments and consider the following remarks.

Changes to the Specification begin on page 2 of this paper.

The Status of the Claims is reflected in the listing of claims that begins on page 3 of this paper.

Changes to the Drawings begin on page 5 of this paper and include attached drawing sheet(s).

Remarks begin on page 6 of this paper.

An **Appendix** including amended drawing figures is attached following page 6 of this paper.